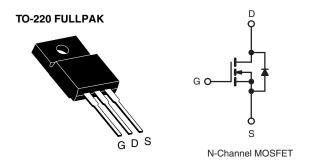
Vishay Siliconix

HALOGEN FREE

## **E Series Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	700			
R <sub>DS(on)</sub> max. at 25 °C (Ω)	V <sub>GS</sub> = 10 V 0.28			
Q <sub>g</sub> max. (nC)	96			
Q <sub>gs</sub> (nC)	11			
Q <sub>gd</sub> (nC)	21			
Configuration	Single			



### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>a</sub>)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	SiHF15N65E-E3
Lead (Pb)-free and Halogen-free	SiHF15N65E-GE3

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			$V_{DS}$	650	V
Gate-Source Voltage			$V_{GS}$	± 30	<b>⊤</b> ′
Continuous Dusin Courset (T. 150 °C) 6	\/ at 10.\/	T <sub>C</sub> = 25 °C		15	
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>e</sup>	VGS at 10 V	$T_C = 25 ^{\circ}\text{C}$ $T_C = 100 ^{\circ}\text{C}$	I <sub>D</sub>	10	Α
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	38	
Linear Derating Factor				0.27	W/°C
Single Pulse Avalanche Energy b			E <sub>AS</sub>	286	mJ
Maximum Power Dissipation			$P_{D}$	34	W
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-Source Voltage Slope $T_J = 125 ^{\circ}\text{C}$		dV/dt	37	1//	
Reverse Diode dV/dt <sup>d</sup>			23	- V/ns	
Soldering Recommendations (Peak Temperature) c for 10 s				300	°C

- a. Repetitive rating; pulse width limited by maximum junction temperature. b.  $V_{DD}=50$  V, starting T $_J=25$  °C, L=28.2 mH,  $R_g=25$   $\Omega$ ,  $I_{AS}=4.5$  A.
- 1.6 mm from case.
- d.  $I_{SD} \le I_D$ , dI/dt = 100 A/µs, starting  $T_J = 25 \,^{\circ}\text{C}$ . e. Limited by maximum junction temperature.



# Vishay Siliconix

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	65	°C/W
Maximum Junction-to-Case (Drain)	$R_{thJC}$	-	3.7	G/ VV

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		-					
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		650	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.75	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2	-	4	V
		V <sub>GS</sub> = ± 20 V		-	-	± 100	nA
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 30 V	-	-	± 1	μA
			= 650 V, V <sub>GS</sub> = 0 V	-	-	1	
Zero Gate Voltage Drain Current	$I_{DSS}$		/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	_	10	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 8 A	-	0.23	0.28	Ω
Forward Transconductance	9fs	V <sub>DS</sub>	s = 30 V, I <sub>D</sub> = 8 A	-	5.6	-	S
Dynamic		•					
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,	-	1640	-	
Output Capacitance	Coss	1	$V_{DS} = 0 V$ , $V_{DS} = 100 V$ ,	-	80	-	1
Reverse Transfer Capacitance	C <sub>rss</sub>	7	f = 1 MHz		4	-	pF
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	V <sub>DS</sub> = 0 V to 520 V, V <sub>GS</sub> = 0 V		-	63	-	
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>			-	213	-	
Total Gate Charge	Qg			-	48	96	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V I <sub>D</sub> = 8 A, V <sub>DS</sub> = 520 V		-	11	-	nC
Gate-Drain Charge	Q <sub>gd</sub>			-	21	-	
Turn-On Delay Time	t <sub>d(on)</sub>			-	18	36	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> = 520 V, I <sub>D</sub> = 8 A,		-	24	48	no
Turn-Off Delay Time	t <sub>d(off)</sub>		= 10 V, $R_g = 9.1 \Omega$	-	48	96	ns
Fall Time	t <sub>f</sub>			-	25	50	
Gate Input Resistance	$R_g$	f = 1	MHz, open drain	-	0.8	-	Ω
<b>Drain-Source Body Diode Characteristic</b>	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET sym	bol	-	-	15	•
Pulsed Diode Forward Current	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	38	A
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 8 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Reverse Recovery Time	t <sub>rr</sub>	1		-	325	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 8 \text{A},$		-	4.6	-	μC
Reverse Recovery Current	I <sub>RRM</sub>	dl/dt = 100 A/µs, V <sub>R</sub> = 400 V		_	20	_	Α

### Notes

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ . b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

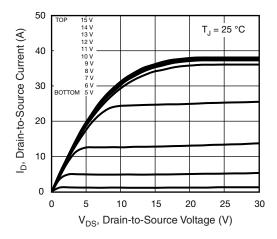


Fig. 1 - Typical Output Characteristics

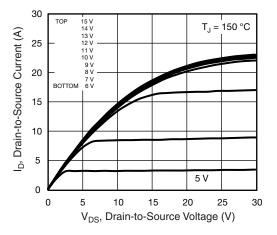


Fig. 2 - Typical Output Characteristics

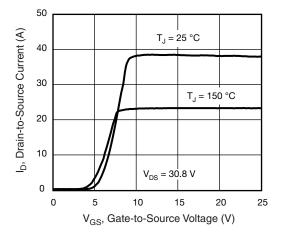


Fig. 3 - Typical Transfer Characteristics

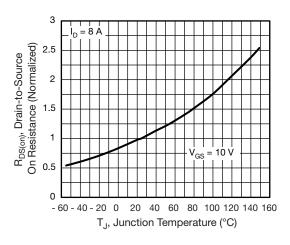


Fig. 4 - Normalized On-Resistance vs. Temperature

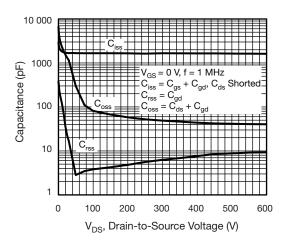


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

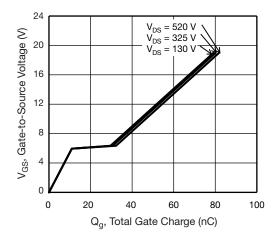


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



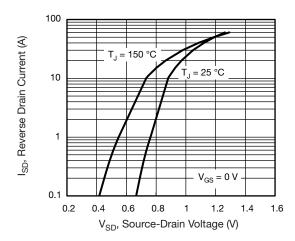


Fig. 7 - Typical Source-Drain Diode Forward Voltage

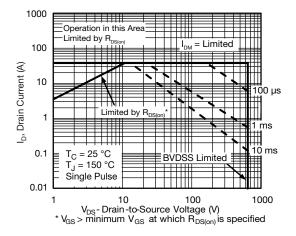


Fig. 8 - Maximum Safe Operating Area

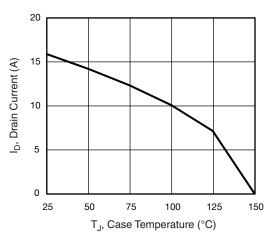


Fig. 9 - Maximum Drain Current vs. Case Temperature

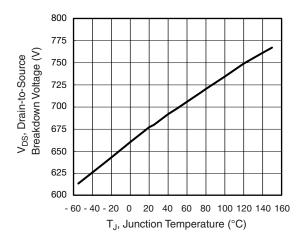


Fig. 10 - Temperature vs. Drain-to-Source Voltage

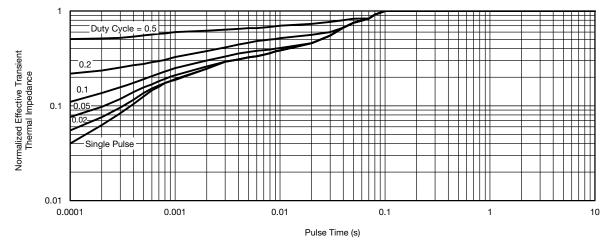


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



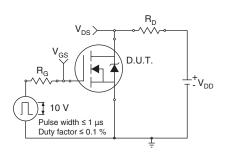


Fig. 12 - Switching Time Test Circuit

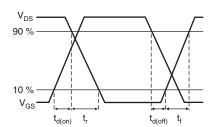


Fig. 13 - Switching Time Waveforms

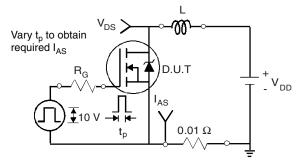


Fig. 14 - Unclamped Inductive Test Circuit

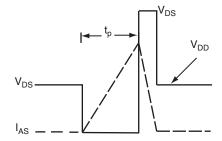


Fig. 15 - Unclamped Inductive Waveforms

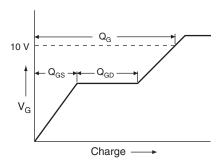


Fig. 16 - Basic Gate Charge Waveform

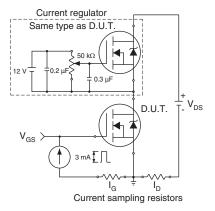
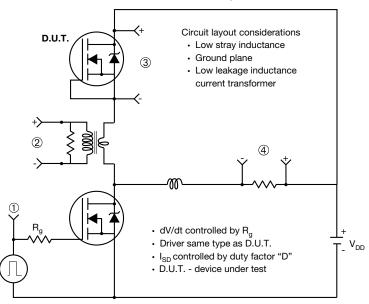


Fig. 17 - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



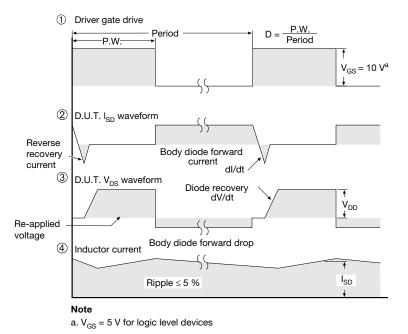


Fig. 18 - For N-Channel

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Vishay Siliconix

# **TO-220 FULLPAK (High Voltage)**

### **OPTION 1: FACILITY CODE = 9**



		MILLIMETERS	
DIM.	MIN.	NOM.	MAX.
Α	4.60	4.70	4.80
b	0.70	0.80	0.91
b1	1.20	1.30	1.47
b2	1.10	1.20	1.30
С	0.45	0.50	0.63
D	15.80	15.87	15.97
е		2.54 BSC	
E	10.00	10.10	10.30
F	2.44	2.54	2.64
G	6.50	6.70	6.90
L	12.90	13.10	13.30
L1	3.13	3.23	3.33
Q	2.65	2.75	2.85
Q1	3.20	3.30	3.40
ØR	3.08	3.18	3.28

### **Notes**

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet  $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
- 6. Facility code will be the 1st character located at the 2nd row of the unit marking



### **OPTION 2: FACILITY CODE = Y**



MILLIMETE		ETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
Е	10.360	10.630	0.408	0.419	
е	2.54	2.54 BSC		0.100 BSC	
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØΡ	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

ECN: E19-0180-Rev. D, 08-Apr-2019

DWG: 5972

#### Notes

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet  $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
- 6. Facility code will be the 1st character located at the 2nd row of the unit marking



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